SHARP

Spec No.	DG-133040
Issue	03-Apr-13

SPECIFICATIONS

Product Type

ZENIGATA LED

Model No.

GW6TGCBG30C

%These specifications contain <u>15</u> pages including the cover and appendix. If you have any objections, please contact us before issuing purchasing order.

CUSTOMERS ACCEPTANCE

DATE: _____

BY:

Reference

PRESENTED

BY: T. Uemura Dept. General Manager

REVIEWED BY: PREPARED BY:

Development Department II Lighting Device Division Electronic Components And Devices Group SHARP CORPORATION

Model No. **GW6TGCBG30C**



- Handle this document carefully for it contains material protected by international copyright law. Any reproduction, full or in part, of this material is prohibited without the express written permission of the company.
- When using the products covered herein, please observe the conditions written herein and the precautions outlined in the following paragraphs. In no event shall the company be liable for any damages resulting form failure to strictly adhere to these conditions and precautions.
 - (1) Please do verify the validity of this part after assembling it in customer's products, when customer wants to make catalogue and instruction manual based on the specification sheet of this part.
 - (2) The products covered herein are designed and manufactured for the following application areas. When using the products covered herein for the equipment listed in paragraph (3), even for the following application areas, be sure to observe the precautions given in Paragraph (3). Never use the products for the equipment listed in Paragraph (4).
 - •Office electronics
 - ·Instrumentation and measuring equipment
 - Machine tools
 - ·Audiovisual equipment
 - •Home appliances
 - ·Communication equipment other than for trunk lines
 - (3) These contemplating using the products covered herein for the following equipment which demands high reliability, should first contact a sales representative of the company and then accept responsibility for incorporating into the design fail-safe operation, redundancy, and other appropriate measures for ensuring reliability and safety of the equipment and the overall system.
 - •Control and safety devices for airplanes, trains, automobiles, and other
 - transportation equipment
 - •Mainframe computers
 - •traffic control systems
 - ·Gas leak detectors and automatic cutoff devices
 - ·Rescue and security equipment
 - ·Other safety devices and safety equipment, etc.
 - (4) Do not use the products covered herein for the following equipment which

demands extremely high performance in terms of functionality, reliability, or accuracy.

- ·Aerospace equipment
- ·Communications equipment for trunk lines
- ·Control equipment for the nuclear power industry
- ·Medical equipment related to life support, etc.
- (5) please direct all queries and comments regarding the interpretation of the above four Paragraphs to a sales representative of the company.
- Please direct all queries regarding the products covered herein to a sales representative of the company.

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GW6TGCBG30C specifications		
1. Application		
These specifications apply to the light emitting diode module Model No. GW	V6TGCBG30C.	
[LED module (InGaN Blue LED chip + Phosphor)]		
Main application : Lighting		
2. External dimensions and equivalent circuit Refer to	o Page 2.	
3. Ratings and characteristics Refer to	o Page 3 - 4.	
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3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power Dissipation *1,4,5	Р	34.0	W
Forward Current *1,4,5	I _F	840	mA
Reverse Voltage *2,4	V _R	-15	V
Operating Temperature *3	T _{opr}	$-30 \sim +100$	°C
Storage Temperature	T _{stg}	- 40 ~ + 100	°C

*1 Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

*2 Voltage resistible at initial connection error

(Not dealing with the possibility of always-on reverse voltage.)

*3 Case temperature Tc (Refer to measuring point for case temperature in the next page.)

Refer to "Derating curve" in the next page as for operating current.

*4 $T_c = 25 \ ^{\circ}C$

*5 Absolute maximum of Power Dissipation and Forward Current are for summation of 1-3(warm white) and 2-4(cool white), not for individual value of each input.

 $(T_j = 25 \ ^{\circ}C)$

CCT	Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
	Forward Voltage *5	V _F		34	37	40	V
	Luminous Flux *6			1650	(1840)	-	lm
2700K	Chromaticity Coordinates *7	х	$I_F\!=\!700\ mA$	-	(0.458)	-	-
	Chromaticity Coordinates 7	у	lf_1-3	-	(0.412)	-	-
	General Color Rendering Index *8	Ra		93	(96)	-	-
	Forward Voltage *5	V _F		35	38	41	V
	Luminous Flux *6	Φ		1950	(2170)	-	lm
5700K	Chromaticity Coordinates *7	х	$I_F\!=~700\ mA$	-	(0.330)	-	-
	Chromaticity Coordinates 7	у	lf 2-4	-	(0.340)	-	-
	General Color Rendering Index *8	Ra	_	87	(90)	-	-

3-2. Electro-optical characteristics

(Note) Values inside parentheses are shown for reference purpose only.

*5 (After 20 ms drive, Tj = 25 °C, Measurement tolerance: \pm 3 %)

*6 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400

- (After 20 ms drive, Tj = 25 °C, Measurement tolerance: \pm 10 %)
- *7 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Tj = 25 °C, Measurement tolerance: \pm 0.005)
- *8 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Tj = 25 $^{\circ}$ C, Measurement tolerance: ± 2)



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4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1.7	Fest items and test condit	tions	Co	nfidence le	vel: 90 %
No.	Test item	Test conditions	Samples	Defective	LTPD
			n	C	(%)
1	Temperature Cycle	- 40 °C(30 min) \sim + 100 °C(30 min), 100 cycles			
			11	0	20
2	Temperature Humidity	$T_{stg} = +60 ^{\circ}\text{C}, \text{RH} = 90 ^{\circ}\text{, Time} = 1000 \text{ h}$			
	Storage		11	0	20
3	High Temperature	$T_{stg} = +100^{\circ}C$, Time = 1000 h			
	Storage		11	0	20
4	Low Temperature	$T_{stg} = -40 \text{ °C}, \text{ Time} = 1000 \text{ h}$			
	Storage		11	0	20
5	Steady State Operating	$T_c = 90 ^{\circ}\text{C}, I_F = 700 \text{ mA}, \text{ Time} = 1000 \text{ h}$			
	Life		11	0	20
6	Shock	Acceleration: 15000 m/s ² , Pulse width: 0.5 ms			
		Direction: 3 directions (X, Y and Z)			
		3 trials in each direction	5	0	50
7	Vibration	Frequency: 100 to 2000 Hz for 4 minutes per trial			
		Acceleration: 200 m/s ²			
		Direction: 3 directions (X, Y and Z)			
		4 trials in each direction	5	0	50

4-2. Failure criteria

	anare enterna		
No.	Parameter	Symbol	Failure criteria
1	Forward Voltage	V _F	$V_F > Initial value \times 1.1$
2	Luminous Flux	Φ	Φ < Initial value × 0.7

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5-1. /	ality level Applied standard SO2859-1				
А	C	on mpling plan, level S-4. and defect criteria			
No.	Item	Defect criteria	Classification	AQL	,
1	No radiation	No light emitting	Major defect	0.1	
2	Electro-optical characteristics	Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity)			
3	External dimensions	Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2)			
4	Appearance	 Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by. < If any question arises regardless of above mentioned criterion> Foreign material, scratch, or bubble at emitting area: 0.8 mm φ Fiber generation at emitting area: 0.2 mm in width and 2.5 mm in lengt Foreign material at connection terminal: 0.8 mm φ Substrate burr on edge: Over dimension tolerance 	Minor defect h	0.4	

(Note) Products with removable foreign material attached on is not determined to be defective.

(Note) Substrate cracks that do not effect the electrical/optical charecteristics are not determined to be defective.

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6. Supple	ements								
6-1. Chro	omaticity ra	nk table					(Tolerance) ($I_F = 700 \text{ m}$	e: x,y \pm 0.005) A, T _j = 25 °C)	
ランク			(Chromatic	ity Diagra:	m]		
]]]		-	Point 1	Point 2	Point 3	Point 4			
	2700K	Х	0.4552	0.4480	0.4608	0.4680	_		
1	270011	у	0.4220	0.4020	0.4020	0.4220	-		
	5700K	x y	0.3269	0.3200	0.3331 0.3300	0.3400	_		
				Ch	romaticity I	Diagram			
0.460									
0.440									
				·				•]	
0.440									
0.440 0.420							270	и	
0.440 0.420 0.400		 		· · · · · · · · · · · · · · · · · · ·			2700 3000K	ок	
0.440 0.420 0.400 ≻ 0.380		5700K		· · · · · · · · · · · · · · · · · · ·				0K	
0.440 0.420 0.400 ≻ 0.380 0.360				· · · · · · · · · · · · · · · · · · ·				ок	
0.440 0.420 0.400 ≻ 0.380 0.360 0.340 0.320 0.300		5700K	0.340	0.360	0.380	 	3000K	ок 440 0.460 0.48	0
0.440 0.420 0.400 ≻ 0.380 0.360 0.340 0.320 0.300			7			0.400 x	3000K		0





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7. Precautions		
① Storage conditions		
Please follow the conditions below.		
• Before opened: Temperature 5 \sim 30 °C, Relative humidity less th	an 60 %.	
(Before opened LED should be used within a year)		
• After opened: Temperature 5 \sim 30 °C, Relative humidity less that	n 60 %.	
(Please use it promptly after opened.)		
• After opened LED should be kept in an aluminum moisture proof b	ag with a moisture	
absorbent material (silica gel).		
• Avoid exposing to air with corrosive gas.		
② Usage conditions		
This product is not designed for the use under any of the following of	conditions.	
Please confirm performance and reliability well enough if you use u		ions;
•In a place with a lot of moisture, dew condensation, briny air, and c	orrosive gas.	
(Cl, H2S, NH3, SO2, NOX, etc.)		
•Under the direct sunlight, outdoor exposure, and in a dusty place.		
•In water, oil, medical fluid, and organic solvent.		
•Please do not use component parts like rubber which may contain s	ulfur (gasket packing, adhesive	materia
etc.).		
③ Heat radiation and Installation		
If forward current (IF) is applied to single-state module at any curre	nt, there is a risk of damaging L	ED
or emitting smoke, due to increase in temperature.		
Equip with specified heat radiator(heat sink), and avoid heat being s		
Material of substrate is alumina ceramic. If installed inappropriately,		
occur, which may result in board cracks or lighting defects due to o	verheat. Please take particular n	otice fo
installation.		
 Refer to the following cautions while installing the LED device on h Apply thermolysis adhesive, adhesive sheet or peculiar connector 		
In case of applying adhesive or adhesive sheet only, check the eff		
If LED comes off from heat radiator, unusual temperature rise en	_	-
device deterioration, and emitting smoke, along with LED devic		uunig
 When LED device is mechanically fixed or locked, Please take in 		nethod
attachment due to fail from stress.	tio constactation regarating the r	nethoù
 Avoid convexly uneven boards. 		
Convex board is subject to substrate cracking or debasement of h	eat release.	
• It is recommended to apply adhesive or adhesive sheet with high		
for radiation of heat effectively.	5	
• Please take care about the influence of color change of adhesive	or adhesive sheet in initial and lo	ong tern
period, which may affect light output or color due to change of re-		

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 Do not touch resin part including white resin part on the surface of LED. No light emission may occur due to damage of resin or cutting wire of LE When using tweezers, please handle by ceramic substrate part and avoid to For mounting, please handle by side part of ceramic or the specified area started area and the specified area area and the specified area area and the specified area area. 	ouching resin part.	
 Handling area ——————————————————————————————————	-	-
materials may influence the output of LED device. Especially, the color cha ong-term use has direct impact on output of LED devices, and hence careful while choosing the radiation sheet ro adhesive.	nge that occur due to 1	
 ④ Connecting method •This product is designed only for contact connection, and not designed for set •In case of solder connection, please use the LED device that supports solder •In case of contact connection, check whether the connection is done properly and also carefully check the reliability before using. 	joint.	
⑤ Static electricity This product is subject to static electricity, so take measures like wearing write Install circuit protection device to drive circuit, if necessary.	st band to cope with it.	
6 Drive methodAny reverse voltage cannot be applied to LEDs when they are in operation	or not.	
 Design a circuit so that any flow of reverse or forward voltage can not be ap when they are out of operation. •Module is composed of LEDs connected in both series and parallel. Constant voltage power supply runs off more than specified current amount caused by temperature rise. Constant current power supply is recommended 	plied to LEDs due to lowered VF to drive.	
•Be cautious while putting on/off the power supply, as excess current, excess injucted to the device in some cases.	s voltage or reverse volta	ge may ge

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⑦ C1	eaning		
	woid cleaning, since LED device may be effected in some cases by cleaning		
8 Cc	lor-tone variation		
C	promaticity of this product is monitored by integrating sphere right after the	operation.	
C	promaticity varies depending on measuring method, light spread condition,	or ambient temperature.	
Pl	ease verify your actual conditions before use.		
9 Sa	fety		
۰L	ooking directly at LEDs for a long time may result in hurting your eyes.		
۰Ir	case that excess current (over ratings) is supplied to the device, hazardous	phenomena including	
a	pnormal heat generation, emitting smoke, or catching fire can be caused.		
Т	ake appropriate measures to excess current and voltage.		
	lease confirm the safety standards or regulations of application devices.		
۰P	lease be careful with substrate edges, that may injure your hands.		
10 Ot	her cautions		
	uarantee covers the compliance to the quality standards mentioned in the sp		
	wever it does not cover the compatibility with application of the end-use, in	cluding assembly	
	d usage environment.		
	case any quality problems occurred in the application of end-use, details with	ill be separately discusse	ed
ar	d determined between the parties hereto.		

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